



- NOTES:
- 1.PLATING THICKNESS
 Ni:1.27~8.89 MICRON.
 Au:0.30 MICRON MIN.
 (EXCEPT 0.30~1.00 MICRON AT SOLDER PADS.)
 - 2.CONNECTION.
 (A-C),(B-D),(E-2-J-5/R),(F-3),(G-4),(H-1)
 - 3.CAMBER : 50.00 MICRON MAX.
 - 4.METALLIZATION RUNDOWN 0.20 MAX.
 - 5.EXPOSURE OF CERAMIC SURFACE AND METALLIZED PATTERN OCCURRED BY MISALIGNMENT OF THE UPPER LAYER, SHALL BE ALLOWED.
 6. PART TO BE SHOWN AS SIDE METALLIZED PATTERN.
 - 7.STRESS RELAXATION DESIGN SHALL BE APPLIED ON THIS ITEM.
 - 8.SEALING METHOD OF THIS PRODUCT SHALL BE SEAM WELD.

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TOLERANCE	REVISION					SBB ATTACHED EXCEPTIONS SHEET.					TITLE	
\pm $\times\times$ ±1% $\times\times\times$ N.L.T.±0.13 ANGLES	SCALE	DIMENSION	PROJECTION	CUSTOMER DWG NO.	REV.						CF5035 PKG	
	12 : 1	mm	3rd								PART NO.	REV.
MATERIAL	APPROVED	CHECKED	ENGRG	CHECKED	DESIGNED						S5070CLK2	1
90%MIN.A1203 (INA-31B BLACK)	Shigetomi	Kawamura	Ohba	Kumura	Sugi						DWG NO.	SHT/OF
	Dec.13.02	Dec.13.02	Dec.13.02	Dec.13.02	Dec.13.02						M03111-40	1/6